

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q76633

Takashi UDAGAWA

Appln. No.: 10/561,438

Group Art Unit: 2811

Confirmation No.: 6378

Examiner: Not Yet Assigned

Filed: December 20, 2005

For: N-TYPE OHMIC ELECTRODE FOR N-TYPE GROUP III NITRIDE
SEMICONDUCTOR, SEMICONDUCTOR LIGHT-EMITTING DEVICE WITH THE
ELECTRODE, AND METHOD FOR FORMING N-TYPE OHMIC ELECTRODE

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination

Filing Receipt Correction

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Assignment for Published Patent Application

~~SHOWA DENKO K.K., Tokyo, JAPAN~~ SHOWA DENKO K.K.

Verification for the requested correction is indicated on the Executed Assignment
Document filed December 20, 2005.

Respectfully submitted,



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WASHINGTON OFFICE

23373

CUSTOMER NUMBER

Date: March 21, 2007



UNITED STATES PATENT AND TRADEMARK OFFICE

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APPL NO.	FILING OR 371 (S) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/561,438	12/20/2005	2811	1100	Q76633	6	11	4

CONFIRMATION NO. 6378

23373
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 WASHINGTON, DC 20037

FILING RECEIPT



OC00000022312290

DOCKETED

FEB 28 2007

Date Mailed: 02/26/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Takashi Udagawa, Saltama, JAPAN;

Assignment For Published Patent Application

[SHOWA DENKO K.K., Tokyo, JAPAN]

SHOWA DENKO K.K.Power of Attorney: The patent practitioners associated with Customer Number 23373.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/10556 07/16/2004
 which claims benefit of 80/489,108 07/23/2003

Foreign Applications

JAPAN 2003-197927 07/16/2003

If Required, Foreign Filing License Granted: 02/02/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/561,438**

Projected Publication Date: 05/17/2007

Non-Publication Request: No

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert
ASSIGNEE's
Name(s)
Address(es))

SHOWA DENKO K.K.

13-9, Shiba Daimon 1-chome, Minato-ku, Tokyo 105-8518, Japan

(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of
Invention)

n-TYPE OHMIC ELECTRODE FOR n-TYPE GROUP III NITRIDE SEMICONDUCTOR, SEMICONDUCTOR
LIGHT-EMITTING DEVICE WITH THE ELECTRODE, AND METHOD FOR FORMING n-TYPE OHMIC

ELECTRODE

relating to International Patent Application PCT/JP. 2004 / 010556 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(Insert date
of execution
of application,
if not
concurrent)

(a) executed on _____;

(b) filed on _____,
Serial No. _____;

() is hereby authorized to insert in (b) the specified
data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

1. *Takashi Udagawa*
(SIGNATURE)

Takashi Udagawa
(TYPE NAME)

October 31, 2005
(DATE)

2. _____
(SIGNATURE)

(TYPE NAME)

(DATE)

3. _____
(SIGNATURE)

(TYPE NAME)

(DATE)